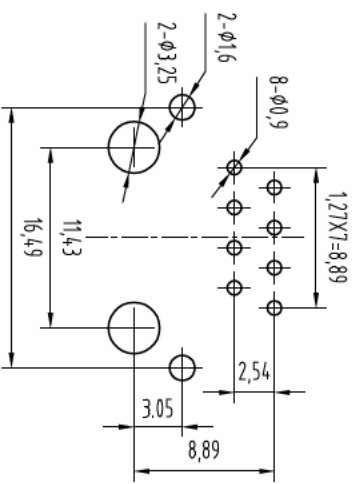
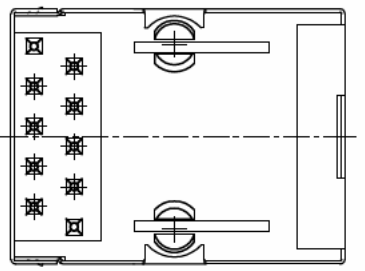
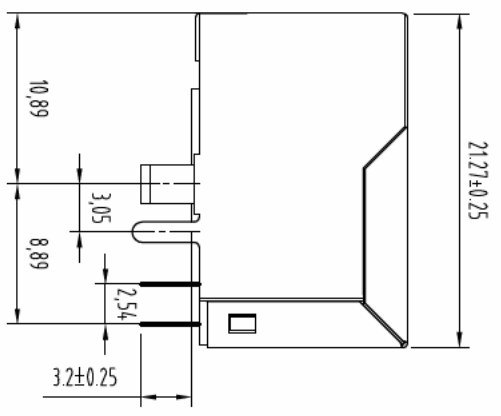
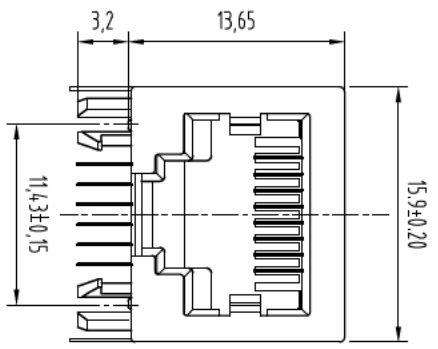


REVISION RECORD				
REV	ECO	DESCRIPTION	DRFT	CHKD



PC Board Layout
Component Side Shown

NOTES:

MATERIAL :

- 1.HOUSING MATERIAL
 - 2.CONTACT MATERIAL
 - 3.PLATING
 - 4.SHIELD
- ELECTRICAL:
- 1.VOLTAGE RATING
 - 2.CURRENT RATING
 - 3.CONTACT RESISTANCE
 - 4.INSULATION RESISTANCE
 - 5.DIELECTRIC WITHSTANDING RESISTANCE
- MECHANICAL:
- 1.DURRABILITY
 - 2.P/PB RETENTION PRE-SOLDER
- ENVIRONMENTAL:
- 1.STORAGE
 - 2.OPERATION

- :GLASS FILLED POLYESTER UL94V-0.
- :PHOSPHOR BRONZE Ø0.45mm.
- :GOLD PLATING OVER NICKEL. **GOLD : 1.27 um**
- :Ø20mm THICKNESS COPPER ALLOY WITH NICKEL PLATED.
- :25 VAC RMS.
- :15 AMP.
- :30 MILLIONHS MAX.
- :500 MEGOHMS MIN @ 500V DC.
- :1000V AC RMS 50HZ. MIN.
- :750 CYCLES MIN.
- :1 LB MIN.
- : -40°~+85°
- : 0°c TO 70°c

DIMENSIONS		UNIT	
MM	INCH	MM	INCH
TOLERANCES EXCEPT AS NOTED			
M	F	M	F
±0.15	±0.005	±0.15	±0.005
±0.05	±0.002	±0.05	±0.002
ANGLES & 45			
THIRD ANGLE PROJECTION			

DRFTD. SMO	DATE: 2016.09.30
CHND. LAMPD	DATE: 2016.09.30
WGD.	DATE:
APPLD.	DATE:
MATERIAL :	
QTY :	
FINISH :	
SCALE :	

TITLE	
SM C04 0060 88 AA	
DRAWING NO.	SIZE
/PART NO.	A3
DO NOT SCALE DRAWING	REV 0
SHEET X	OF Y



8 7 6 5 4 3 2 1